RF SWITCH

CG2409M2

High Power SPDT RF Switch

DESCRIPTION

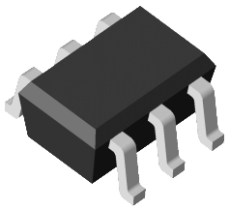
- The CG2409M2 is a GaAs MMIC high power SPDT (Single Pole Double Throw) switch which was designed for WiMAX and Wireless LAN applications

FEATURES

- Control voltage:
  VC(H) = 1.8 to 5.0 V (3.0V TYP.)
  VC(L) = -0.2 to 0.2 V (0V TYP.)
- Low insertion loss:
  $L_{ins}1$ = 0.35 dB TYP. @ f = 1.0 GHz
  $L_{ins}2$ = 0.42 dB TYP. @ f = 2.5 GHz
  $L_{ins}3$ = 0.45 dB TYP. @ f = 3.0 GHz
- High isolation:
  ISL1 = 34 dB TYP. @ f = 1.0 GHz
  ISL2 = 30 dB TYP. @ f = 2.5 GHz
  ISL3 = 26 dB TYP. @ f = 3.0 GHz
- Power Handling
  $P_{in(0.1dB)}$ = +36.5 dBm TYP. @ f = 0.4 to 3.8 GHz,
  VC(H) = 3.0 V, VC(L) = 0 V

PACKAGE

- 6-pin mini mold Package
  (2.0mm x 1.25mm x 0.9mm)



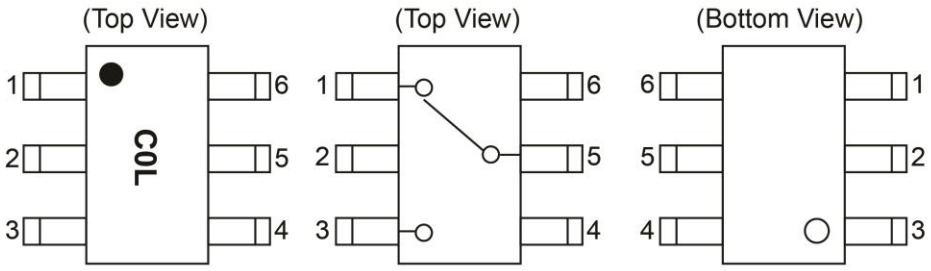
APPLICATIONS

- WiMAX and wireless LAN
  (IEEE802.11 b/g/n)

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Description
CG2409M2	CG2409M2-C4	6-pin mini mold (Pb-Free)	C0L	• Embossed Tape 8 mm wide • Pin 4, 5, 6 face the perforation side of the tape • MOQ 10 kpcs/reel
CG2409M2-EVAL	CG2409M2-EVAL			• Evaluation Board with DC block capacitors, power supply bypass capacitors, and RF and DC connectors • MOQ 1

PIN CONFIGURATION AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	VC2
5	RFC
6	VC1

TRUTH TABLE

VC1	VC2	RFC-RF1	RFC-RF2
High	Low	ON	OFF
Low	High	OFF	ON

ABSOLUTE MAXIMUM RATINGS

(T_A = +25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Control Voltage	VC	6.0 Note 1	V
Input Power	Pin	+38.0 Note 2	dBm
Operating Ambient Temperature	T_A	-45~+85	°C
Storage Temperature	T_{stg}	-55~+150	°C

Note 1. |VC1 - VC2|≦6.0V

2. 3.0V≦|VC1 – VC2|≦5.0V, 0.4GHz≦f≦3.8GHz

RECOMMENDED OPERATING RANGE

(T_A = +25 °C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.05	-	3.8	GHz
Switch Control Voltage (H)	VC(H)	+1.8	+3.0	+5.0	V
Switch Control Voltage (L)	VC(L)	-0.2	0	+0.2	V

ELECTRICAL CHARACTERISTICS

(T_A=+25 °C, VC(H)=3.0V, VC(L)=0V, Zo=50Ω, DC Block Capacitance=8pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins1	f = 0.05 to 0.5 GHz Note 1	-	0.35	0.55	dB
	Lins2	f = 0.5 to 1.0 GHz Note 2	-	0.35	0.55	dB
	Lins3	f = 1.0 to 2.0 GHz Note 2	-	0.40	0.60	dB
	Lins4	f = 2.0 to 2.5 GHz	-	0.42	0.62	dB
	Lins5	f = 2.5 to 3.0 GHz	-	0.45	0.70	dB
	Lins6	f = 3.0 to 3.8 GHz	-	0.50	0.80	dB
Isolation	ISL1	f = 0.05 to 0.5 GHz Note 1	32	35	-	dB
	ISL2	f = 0.5 to 1.0 GHz Note 2	31	34	-	dB
	ISL3	f = 1.0 to 2.0 GHz Note 2	29	32	-	dB
	ISL4	f = 2.0 to 2.5 GHz	27	30	-	dB
	ISL5	f = 2.5 to 3.0 GHz	23	26	-	dB
	ISL6	f = 3.0 to 3.8 GHz	18	21	-	dB
Return Loss	RL1	f = 0.05 to 0.5 GHz Note 1	15	20	-	dB
	RL2	f = 0.5 to 2.0 GHz Note 2	15	20	-	dB
	RL3	f = 2.0 to 3.8 GHz	15	20	-	dB
0.1 dB Loss Compression Input Power Note 3	$P_{in(0.1dB)}$	f = 0.4 to 3.8 GHz	-	+36.5	-	dBm
2nd Harmonics	2f0	f = 2.5 GHz, P_{in}=+26dBm	-	80	-	dBc
3rd Harmonics	3f0	f = 2.5 GHz, P_{in}=+26dBm	-	85	-	dBc
Input 3rd Order Intercept Point	IIP3	f = 2.5GHz 2-tone 1MHz Spacing	-	+62	-	dBm
Error Vector Magnitude	EVM	802.11g, 64QAM, 54Mbps, Pin≦+25dBm	-	0.5	-	%
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	100	-	ns
Switch Control Current	Icont	Non RF	-	7	-	μA

Note 1 DC block capacitance = 1,000pF at f=0.05 to 0.5 GHz

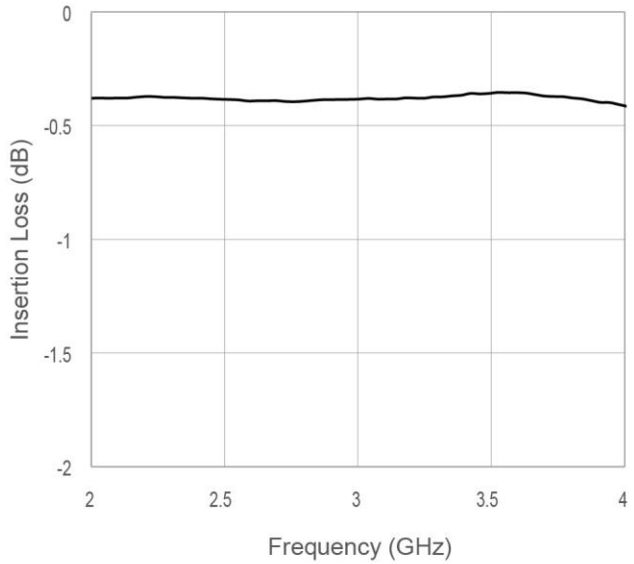
Note 2 DC block capacitance = 56pF at f=0.4 to 2.0 GHz

Note 3 P_{in}(0.1dB) is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

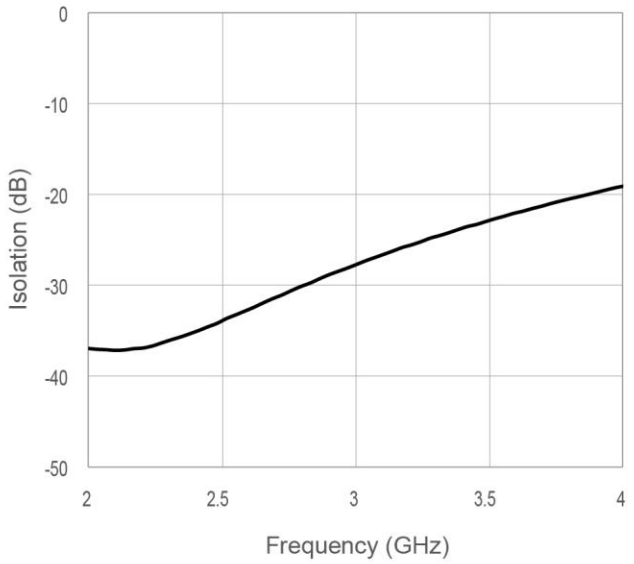
TYPICAL CHARACTERISTICS

(VC(H)=3V, VC(L)=0V, T_A = +25˚C, DC Block Capacitance=8pF, unless otherwise specified. Through board loss is subtracted in insertion loss data)

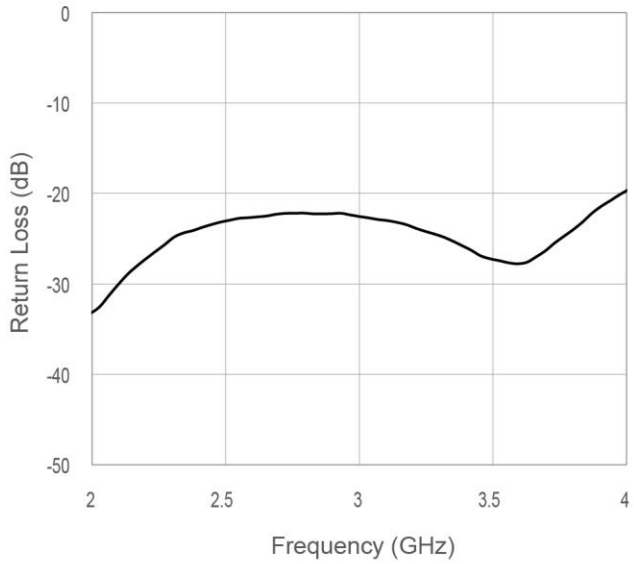
Typical Insertion Loss vs. Frequency



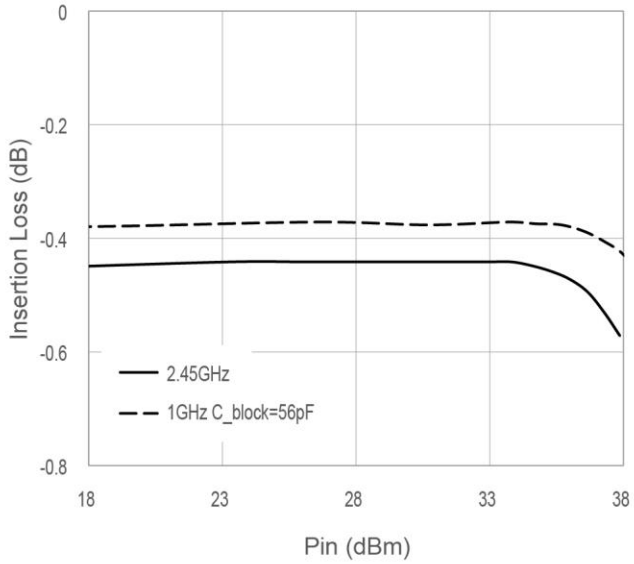
Typical Isolation vs. Frequency



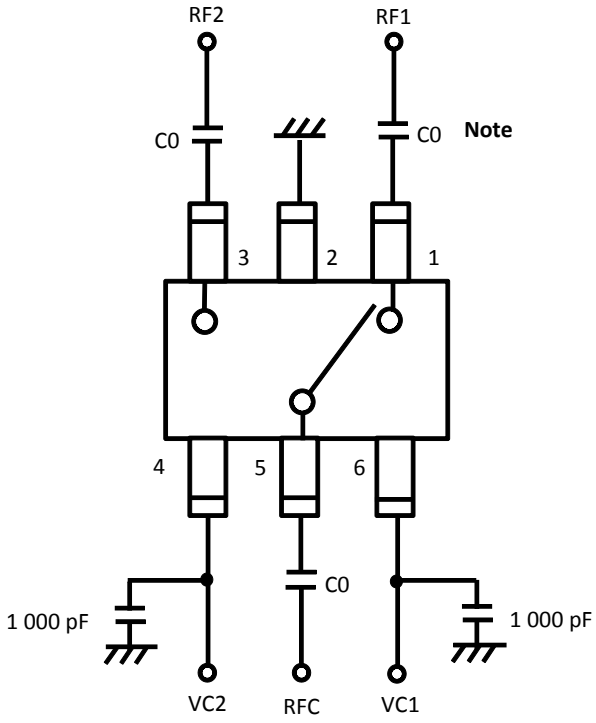
Typical Return Loss vs. Frequency



Typical Insertion Loss vs. Input Power



EVALUATION CIRCUIT

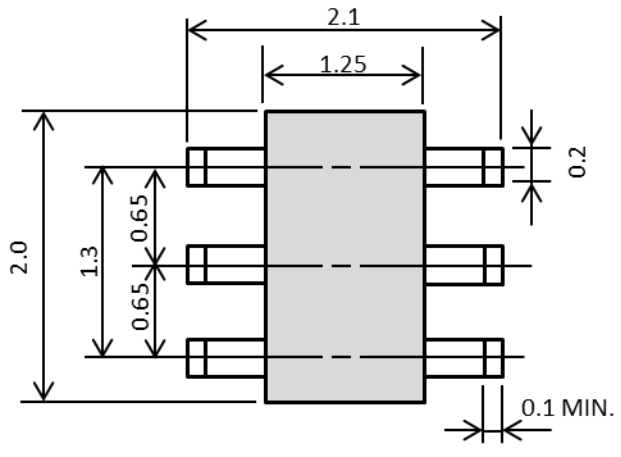


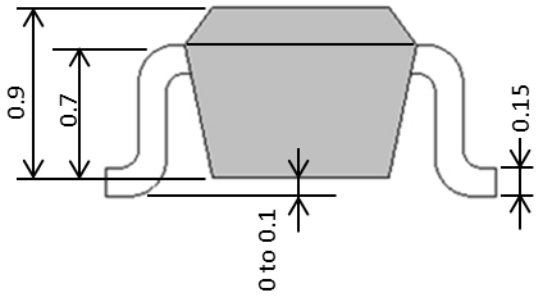
Note C0 : 0.05 to 0.5 GHz 1,000pF
: 0.4 to 2.0 GHz 56pF
: 2.0 to 3.8 GHz 8pF

The application circuits and their parameters are for reference only and are not intended for use in actual designs.
DC Block Capacitors are required at all RF ports.

PACKAGE DIMENSIONS

6-pin mini mold package (Unit: mm)





RECOMMENDED SOLDERING CONDITIONS

Recommended Soldering Conditions are available on CEL's Part Summary page under Associated Documents

REVISION HISTORY

Version	Change to current version	Page(s)
CDS-0032-01 (Issue A) September 14, 2016	Preliminary Datasheet	N/A
CDS-0032-02 (Issue B) December 27, 2016	Revised Electrical Characteristics table Added “Recommended Soldering Conditions” section	3, 5
CDS-0032-03 (Issue C) March 14, 2017	Initial datasheet Revised Electrical Characteristics table	3
CDS-0032-04 (Issue D) September 14, 2017	Updated Applications section Updated Characteristics tables and added Error Vector Magnitude Added “Typical Characteristics” graphs section	1, 3, 4

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[CAUTION]

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CEL Headquarters • 4590 Patrick Henry Drive • Santa Clara, CA 95054 • Tel: (408) 919-2500 • www.cel.com

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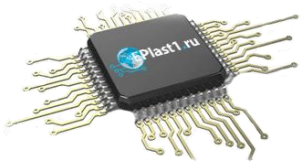

Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.